



AO6801

Dual P-Channel Enhancement Mode Field Effect Transistor

General Description

The AO6801 uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications. Standard Product AO6801 is Pb-free (meets ROHS & Sony 259 specifications). AO6801L is a Green Product ordering option. AO6801 and AO6801L are electrically identical.

Features

 $V_{DS}(V) = -30V$

 $I_D = -2.3 \text{ A } (V_{GS} = -10 \text{V})$

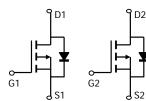
 $R_{DS(ON)}$ < 135m Ω (V_{GS} = -10V)

 $R_{DS(ON)}$ < 185m Ω (V_{GS} = -4.5V)

 $R_{DS(ON)}$ < 265m Ω (V_{GS} = -2.5V)

TSOP6 Top View





Absolute Maximum Ratings T _A =25°C unless otherwise noted							
Parameter		Symbol	Maximum	Units			
Drain-Source Voltage		V_{DS}	-30	V			
Gate-Source Voltage		V_{GS}	±12	V			
Continuous Drain	T _A =25°C		-2.3				
Current ^A	T _A =70°C	I _D	-1.8	Α			
Pulsed Drain Current ^B		I _{DM}	-20				
	T _A =25°C	P_{D}	1.15	W			
Power Dissipation ^A	T _A =70°C		0.73	VV			
Junction and Storage Temperature Range		T_J , T_{STG}	-55 to 150	°C			

Thermal Characteristics								
Parameter	Symbol	Тур	Typ Max l					
Maximum Junction-to-Ambient ^A	t ≤ 10s	$R_{\scriptscriptstyle{ hetaJA}}$	78	110	°C/W			
Maximum Junction-to-Ambient A	Steady-State	$\Gamma_{\theta JA}$	106	150	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	64	80	°C/W			

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC F	PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =-250μA, V _{GS} =0V		-30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-24V, V _{GS} =0V				-1	μА
			T _J =55°C			-5	
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±12V				±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=-250\mu A$		-0.6	-1	-1.4	V
$I_{D(ON)}$	On state drain current	V _{GS} =-4.5V, V _{DS} =-5V		-20			Α
R _{DS(ON)} Static [V _{GS} =-10V, I _D =-2.3A			107	135	mΩ
	Static Drain-Source On-Resistance		T _J =125°C		154	190	1115.2
	Static Dialii-Source Oil-Resistance	V_{GS} =-4.5V, I_{D} =-2A			135	185	mΩ
		V_{GS} =-2.5V, I_{D} =-1A			195	265	mΩ
g _{FS}	Forward Transconductance	V_{DS} =-5V, I_{D} =-2.3A			8		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V		-0.85	-1	V	
Is	Maximum Body-Diode Continuous Current					-1.35	Α
DYNAMIC	CPARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-15V, f=1MHz			409		pF
Coss	Output Capacitance				55		pF
C _{rss}	Reverse Transfer Capacitance				42		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			12		Ω
SWITCHI	NG PARAMETERS						
Q_g	Total Gate Charge	V _{GS} =-4.5V, V _{DS} =-15V, I _D =-2.0A			4.9		nC
Q_{gs}	Gate Source Charge				0.6		nC
Q_{gd}	Gate Drain Charge				1.6		nC
t _{D(on)}	Turn-On DelayTime				6.9		ns
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-15V, R_L =7.5 Ω , R_{GEN} =3 Ω			3.3		ns
t _{D(off)}	Turn-Off DelayTime				38.5		ns
t _f	Turn-Off Fall Time				13.2		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-2.0A, dI/dt=100A/μs			15		ns
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =-2.0A, dI/dt=100A/μs			8		nC

A: The value of $R_{\theta JA}$ is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

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B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using $80\,\mu s$ pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

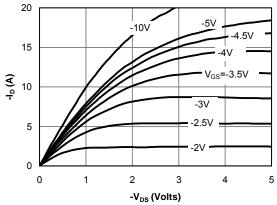


Fig 1: On-Region Characteristics

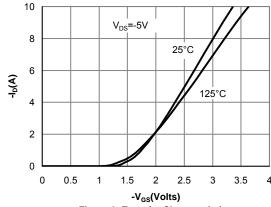


Figure 2: Transfer Characteristics

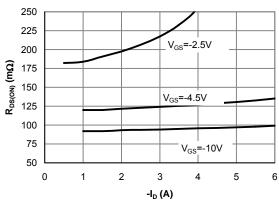


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

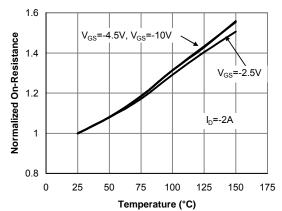


Figure 4: On-Resistance vs. Junction Temperature

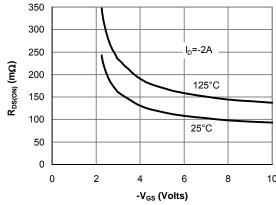


Figure 5: On-Resistance vs. Gate-Source Voltage

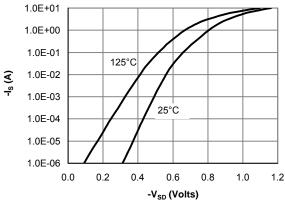


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

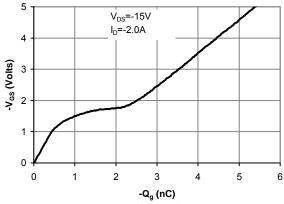


Figure 7: Gate-Charge Characteristics

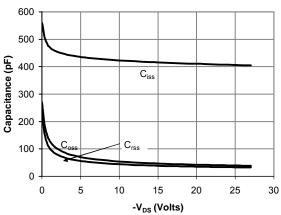


Figure 8: Capacitance Characteristics

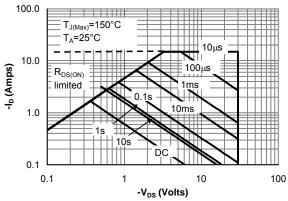


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

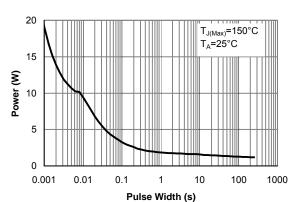


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

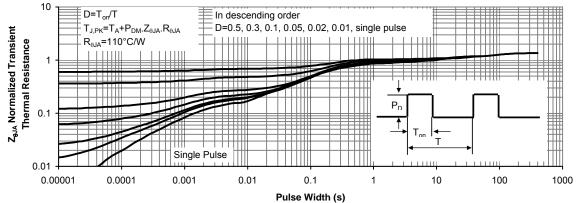


Figure 11: Normalized Maximum Transient Thermal Impedance